

# Low Dropout Dual Regulator

## Description

The SG29055/55A is a dual 5 V/5 V positive voltage regulator. One output is a high current (up to 1000 mA) regulator that can be turned on or off by a high impedance low current TTL compatible switch. The second or standby output remains on regardless. The on/off switch not only shuts off the high current output but actually puts the IC in a micropower mode making possible a low quiescent current. This unique characteristic coupled with an extremely low dropout, (.55 V for output current of 10 mA) makes the SG29055/55A well suited for power systems that require standby memory. The SG29055/55A includes other features which were originally designed for automotive applications. These include protection from reverse battery installations and double battery jumps. The high current regulator has overvoltage shutdown to protect both the internal circuitry and the load during line transients, such as load dump (60 V). In addition, the high current regulator design also has built-in protection for short circuit and thermal overload. During these fault conditions of the primary regulator the standby regulator will continue to power its load.

The SG29055 is the 5 volt,  $\pm 5\%$  version of a family of dual regulators with a standby output voltage of 5 V. Also available is the SG29055A which offers an improved output voltage tolerance of  $\pm 2\%$ . They are available in the plastic TO-220 power package and are designed to function over the automotive ambient temperature range of  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

## Features

- 2% Internally Trimmed Output
- Two Regulated Outputs
- Output Current in Excess of 1000 mA
- Low Quiescent Current Standby Regulator
- Input-Output Differential Less Than 0.6 V at 0.5 A
- Reverse Battery Protection
- 60 V Load Dump Protection
- -50 V Reverse Transient Protection
- Short Circuit Protection
- Internal Thermal Overload Protection
- Available in Plastic TO-220
- ON/OFF Switch for High Current Output

## Block Diagram

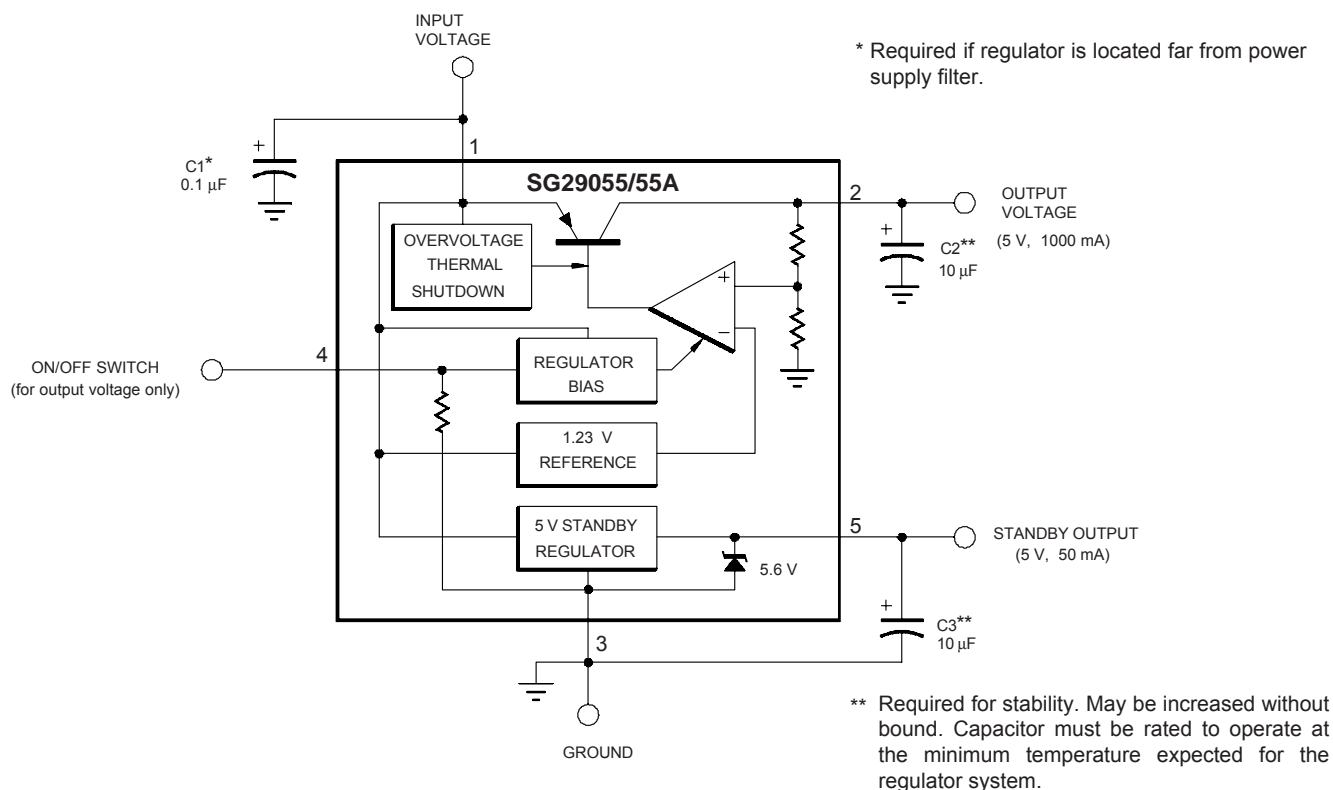


Figure 1 · Block Diagram

## Absolute Maximum Ratings (Note 1 Exceeding these values may destroy this part.)

Input Voltage ( $V_{IN}$ ) Operating .....	26 V	Storage Temperature Range ( $T_{STG}$ ) .....	-65°C to 150°C
Input Voltage ( $V_{IN}$ ) Overvoltage Transient .....	-15 V to 60 V	Operating Junction Temperature ( $T_J$ ) .....	150°C
ON/OFF Switch .....	-0.3 V to $V_{IN}$		

## Thermal Data

Thermal Resistance-Junction to Case, $\theta_{JT}$ .....	4.0°C/W*
Thermal Resistance-Junction to Ambient, $\theta_{JA}$ .....	55°C/W

\* =  $\theta_{JT}$  (Junction to Case)

Note A. Junction Temperature Calculation:  $T_J = T_A + (P_D \times \theta_{JA})$ .

Note B. The above numbers for  $\theta_{JC}$  are maximums for the limiting thermal resistance of the package in a standard mounting configuration. The  $\theta_{JA}$  numbers are meant to be guidelines for the thermal performance of the device pc-board system. All of the above assume no ambient airflow.

## Recommended Operating Conditions (Notes 2 & 3)

Input Voltage ( $V_{IN}$ ) .....	6 V to 26 V	Reverse Polarity D.C. Input Voltage ( $V_{IN}$ )	
ON/OFF Threshold Voltage		( $V_O \geq -0.6$ V, 16 $\Omega$ load) .....	-15 V max.
Low Level, $V_{IL}$ ( $V_{OUT}$ is OFF) .....	0.8 V max.	Reverse Polarity Transient Input Voltage ( $V_{IN}$ )	
High Level, $V_{IH}$ ( $V_{OUT}$ is ON) .....	2.0 V min.	(1% duty cycle, $T \leq 100$ ms, $V_O \geq -9$ V, 16 $\Omega$ load) ..	-50 V max.
Load Current $V_{OUT}$ (with adequate heat sinking) ...	5 to 1000 mA	Output Capacitor with ESR of 1 $\Omega$ max.	
Maximum Line Transient (Load Dump) $V_{SB} \leq 6$ V .....	60 V max.	( $V_{OUT}$ to GND & $V_{SB}$ to GND) .....	10 $\mu$ F min.
Input Capacitor ( $V_{IN}$ to GND) .....	0.1 $\mu$ F min.	Operating Ambient Temperature Range ( $T_A$ )	
		SG29055/55A .....	-40°C to 85°C

Note 2. Range over which the device is functional.

Note 3. During 60 V load dump,  $V_{SB}$  shall not be less than 4.75 V at  $I_{OUT} = 10$  mA.

## Electrical Characteristics

(Unless otherwise specified, these specifications apply for the operating ambient temperature of  $T_A = 25^\circ\text{C}$ .  $V_{IN} = 14$  V.  $I_O = 500$  mA for  $V_{OUT}$  and 10 mA for  $V_{SB}$  and are for DC characteristics only. Low duty cycle pulse testing techniques are used which maintains junction and case temperatures equal to the ambient temperature.)

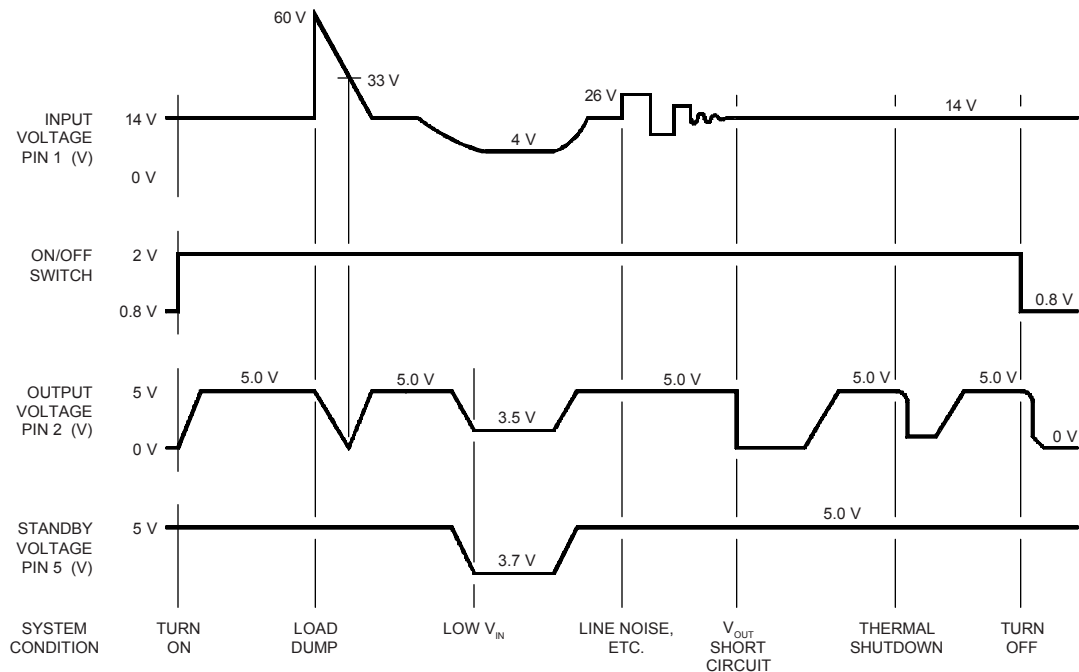
Parameter	Test Conditions	SG29055/55A			Units
		Min.	Typ.	Max.	
Voltage Output (V <sub>OUT</sub> ) Section					
Output Voltage (Note 4)	6 V ≤ V <sub>IN</sub> ≤ 26 V, I <sub>O</sub> ≤ 1000 mA, -40°C ≤ T <sub>A</sub> ≤ 85°C				
	SG29055	4.75	5.00	5.25	V
	SG29055A	4.90	5.00	5.10	V
Line Regulation	6 V ≤ V <sub>IN</sub> ≤ 16 V, I <sub>O</sub> = 5 mA		4	25	mV
	6 V ≤ V <sub>IN</sub> ≤ 26 V, I <sub>O</sub> = 5 mA		10	50	mV
Load Regulation	5 mA ≤ I <sub>O</sub> ≤ 1000 mA		10	50	mV
Output Impedance	500 mA <sub>DC</sub> and 10 mA <sub>RMS</sub> , 100 Hz - 10 kHz		200		mΩ
Quiescent Current	I <sub>O</sub> ≤ 10 mA, No Load on Standby		2		mA
	I <sub>O</sub> = 500 mA, No Load on Standby		40	100	mA
	I <sub>O</sub> = 750 mA, No Load on Standby		90		mA
	I <sub>O</sub> = 220 mA, I <sub>SB</sub> = 10 mA, V <sub>IN</sub> = V <sub>OUT</sub> - 200 mV		15	25	mA
Output Noise Voltage	10 Hz - 100 kHz		100		μV <sub>RMS</sub>
Long Term Stability			20		mV/1000hr
Ripple Rejection	F <sub>O</sub> = 120 Hz		66		dB
Dropout Voltage	I <sub>O</sub> = 500 mA		0.45	0.6	V
	I <sub>O</sub> = 1000 mA	0.7		1.2	V
Current Limit		1.0	1.8	2.5	A
Maximum Operational Input Voltage	Double Battery	26.5	31		V
Maximum Line Transient	V <sub>O</sub> ≤ 5.5 V	60	70		V
ON/OFF Switch (I <sub>IH</sub> )	I <sub>O</sub> = 10 mA, Pin 4 = 2.4 V			50	μA
ON/OFF Switch (I <sub>IL</sub> )	I <sub>O</sub> = 10 mA, Pin 4 = 0.4 V	-10			μA

## Electrical Characteristics (Continued)

Parameter	Test Conditions	SG29055/55A			Units
		Min.	Typ.	Max.	
Standby Output (V <sub>SB</sub> ) Section					
Output Voltage (Note 4)	6 V ≤ V <sub>IN</sub> ≤ 26 V, I <sub>O</sub> ≤ 50 mA, -40°C ≤ T <sub>A</sub> ≤ 85°C	4.75	5.0	5.25	V
Tracking	V <sub>OUT</sub> - Standby Output Voltage		50	200	mV
Line Regulation	6 V ≤ V <sub>IN</sub> ≤ 26 V		4	50	mV
Load Regulation	1 mA ≤ I <sub>O</sub> ≤ 35 mA		10	25	mV
	1 mA ≤ I <sub>O</sub> ≤ 50 mA		25	50	mV
Output Impedance	1 mA <sub>DC</sub> and 1 mA <sub>RMS</sub> , 100 Hz - 10 kHz		1		Ω
Quiescent Current	I <sub>O</sub> ≤ 10 mA, V <sub>OUT</sub> OFF		1.2	3	mA
Output Noise Voltage	10 Hz - 100 kHz		300		μV <sub>RMS</sub>
Long Term Stability			20		mV/1000hr
Ripple Rejection	F <sub>O</sub> = 120 Hz		66		dB
Dropout Voltage	I <sub>O</sub> ≤ 50 mA		0.55	0.7	V
Current Limit		50	100		mA
Maximum Operational Input Voltage	4.75 V ≤ V <sub>O</sub> ≤ 6 V	60	70		V

Note 4. The temperature extremes are guaranteed but not 100% production tested.

## Typical Circuit Waveform



## Application Notes

The advantages of using a low-dropout regulator such as the SG29055/55A are the need for less "headroom" for full regulation, and the inherent reverse polarity protection provided by the PNP output device. A typical NPN regulator design requires an input to output differential of approximately two volts minimum. This is due to the  $2V_{be} + V_{cesat}$  of the NPN Darlington used in the output, coupled with the voltage drop across the current limit resistor. In contrast, the "PNP Regulator" uses a single series pass transistor with its single  $V_{cesat}$ , thus the lower input to output voltage differential or dropout voltage.

In addition to a low dropout voltage, an important advantage of the SG29055/55A series is low quiescent current in the standby mode. When the high current or primary regulator is shut off, the

regulator enters a micropower mode. Here all but the most essential circuitry to power the standby output is deactivated. This allows the lowest possible quiescent current (typical around 1.2 mA), a vital factor when used in a battery powered system.

In some applications the regulator output voltage is used not only as a power supply but also as a voltage reference for control systems. In such cases not just the temperature stability of the output is important but also the initial accuracy. The SG29055/55A fills this need as the internal bandgap reference is trimmed allowing a typical output voltage tolerance of  $\pm 1\%$ .

## Application Hints

### EXTERNAL CAPACITORS

To stabilize the outputs and prevent oscillation (perhaps by many volts) external capacitors are required. The minimum recommended value for the output capacitors is 10  $\mu\text{F}$ , although the actual size and type will likely vary according to the particular application, e.g., operating temperature range and load. Another consideration is the effective series resistance (ESR) of the capacitor. Capacitor ESR will vary by manufacturer. Consequently, some evaluation may be required to determine the minimum value of the output capacitors. Generally worst case occurs at the maximum load and minimum ambient temperature.

The size of the output capacitor can be increased to any value above the minimum. One possible advantage of this would be to maintain the output voltage during brief periods of negative input transients.

The output capacitors chosen should be rated for the full range of ambient temperature over which the circuit will be exposed and expected to operate. For example, many aluminum type electrolytic capacitors will freeze at  $-30^{\circ}\text{C}$ . The effective capacitance is reduced to zero in such a situation. Capacitors rated for  $-40^{\circ}\text{C}$  operation must be used in order to maintain regulator stability at that temperature. Tantalum capacitors satisfy this requirement.

### STANDBY OUTPUT

The SG29055/55A differs from most fixed voltage regulators in that it is equipped with two regulator outputs instead of one. The additional output is intended for use in systems requiring standby memory circuits. While the high current regulator output can be controlled with the ON/OFF pin described below, the standby remains on under all conditions as long as sufficient input voltage is applied to the IC. Thus, memory and other circuits powered by this output remain unaffected by positive line transients, thermal shutdown, etc.

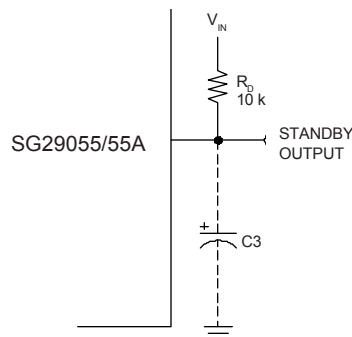
The standby regulator circuit is designed so that the quiescent current to the IC is very low ( $<1.5\text{ mA}$ ) when the other regulator output is off.

If the standby output is not required it can be disabled. This is accomplished by connecting a resistor from the standby output to the supply voltage, thereby also eliminating the requirement for a more expensive output capacitor to prevent unwanted oscillations. The resistor value depends upon the minimum input voltage expected for a given system.

Since the standby output is shunted with an internal 5.6 V

Zener, the current through the external resistor should be sufficient to bias internal resistors up to this point. Approximately 60  $\mu\text{A}$  will suffice, resulting in a 10 k external resistor for most applications (Figure 2).

### HIGH CURRENT OUTPUT



**Figure 2.** Disabling Standby Output to Eliminate C3

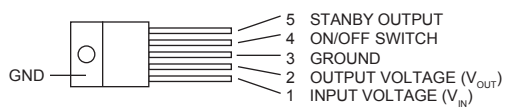
The high current regulated output features fault protection against overvoltage as well as a thermal shutdown feature. If the input voltage rises above 33 V (load dump), the high current output shuts down automatically. The internal circuitry is thus protected and the IC is able to survive higher voltage transients than might otherwise be expected. The thermal shutdown of the high current output effectively guards against overheating of the die since this section of the IC is the principle source of power dissipation on the chip.

### ON/OFF SWITCH

The ON/OFF pin is a high impedance low current switch that controls the main output voltage (pin 2). This is directly compatible with all 5 volt logic families. For use with open collector logic outputs, a 50 k resistor from this pin to a 5 V supply, such as Pin 5, is required.

The SG29055/55A also has an internal pulldown resistor on pin 2 to ground. This resistor, approximately 90 k $\Omega$  in value, ensures the high current switched output remains off unless actively pulled high.

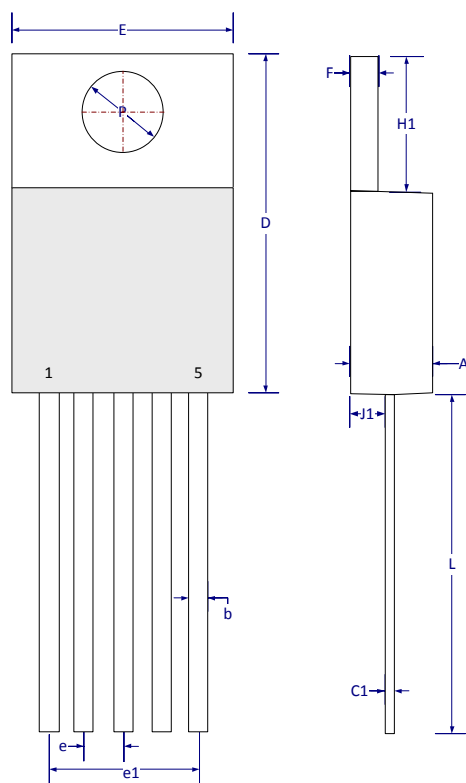
## Connection Diagrams and Ordering Information (See Notes Below)

Package	Part No.	Ambient Temperature Range	Connection Diagram
5-PIN TO-220 PLASTIC P - PACKAGE	SG29055P SG29055AP	$-40^{\circ}\text{C}$ to $85^{\circ}\text{C}$ $-40^{\circ}\text{C}$ to $85^{\circ}\text{C}$	

Note: 1. All parts are viewed from the top.

## Package Outline Dimensions

Controlling dimensions are in inches, metric equivalents are shown for general information.



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	3.56	4.82	0.140	0.190
b	0.46	1.04	0.018	0.040
C1	0.31	1.14	0.012	0.045
D	14.22	16.51	0.560	0.650
E	9.66	10.66	0.380	0.420
e	0.67 TYP		1.70 TYP	
e1	6.80 TYP		0.268 TYP	
F	1.14	1.40	0.045	0.055
H1	5.85	6.85	0.230	0.270
J1	2.04	2.92	0.080	0.115
P	3.56	4.06	0.140	0.160
L	12.70	14.73	0.500	0.580

**Note:**

Dimensions do not include protrusions; these shall not exceed 0.155mm (.006") on any side. Lead dimension shall not include solder coverage.

**Figure 3 • P 5-Pin Plastic TO-220 Package Dimensions**



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